

# HD74LV1GW14A

# Dual Inverter with Schmitt-trigger Input

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#### **Description**

The HD74LV1GW14A has dual inverter with schmitt-trigger input in a 6 pin package. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

#### **Features**

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- Electrical characteristics equivalent to the HD74LV14A

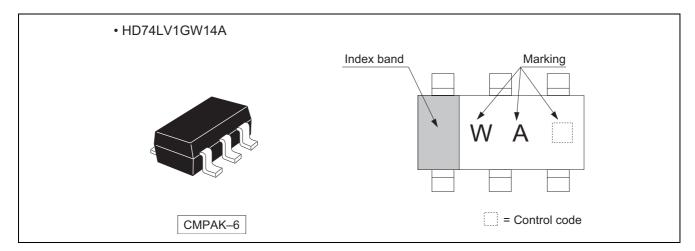
Supply voltage range: 1.65 to 5.5 V

Operating temperature range : -40 to +85°C

- All inputs  $V_{IH}$  (Max.) = 5.5 V (@V<sub>CC</sub> = 0 V to 5.5 V) All outputs  $V_{O}$  (Max.) = 5.5 V (@V<sub>CC</sub> = 0 V)
- Output current  $\pm 6$  mA (@V<sub>CC</sub> = 3.0 V to 3.6 V),  $\pm 12$  mA (@V<sub>CC</sub> = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV1GW14ACME	ICMPAK-6 pin	PTSP0006JA-A (CMPAK-6V)	СМ	E (3,000 pcs / Reel)

#### **Outline and Article Indication**

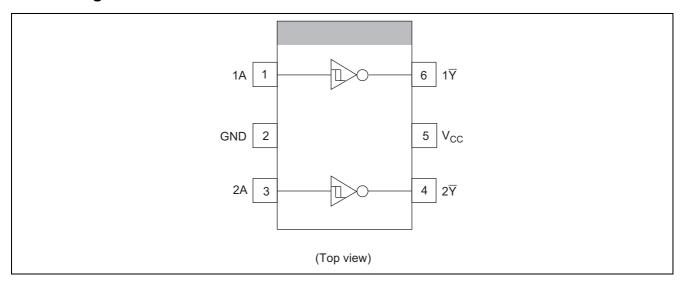


#### **Function Table**

Input A	Output ₹
Н	L
L	Н

H : High level L : Low level

#### **Pin Arrangement**



# **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	Vcc	-0.5 to 7.0	V	
Input voltage range *1	Vı	-0.5 to 7.0	V	
Output voltage range *1, 2	\/	$-0.5$ to $V_{CC} + 0.5$	V	Output : H or L
Output voltage range	V <sub>o</sub>	-0.5 to 7.0		V <sub>CC</sub> : OFF
Input clamp current	I <sub>IK</sub>	-20	mA	V <sub>I</sub> < 0
Output clamp current	lok	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	I <sub>O</sub>	±25	mA	$V_O = 0$ to $V_{CC}$
Continuous current through Vcc or GND	I <sub>CC</sub> or I <sub>GND</sub>	±50	mA	
Maximum power dissipation at Ta = 25°C (in still air) *3	P <sub>T</sub>	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

# **Recommended Operating Conditions**

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V <sub>CC</sub>	1.65	5.5	V	
Input voltage range	Vı	0	5.5	V	
Output voltage range	Vo	0	V <sub>CC</sub>	V	
		_	1		$V_{CC} = 1.65 \text{ to } 1.95 \text{ V}$
	l <sub>OL</sub>	_	2	mA	$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		_	6		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
Output current		_	12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Output current	Іон	_	-1		$V_{CC} = 1.65 \text{ to } 1.95 \text{ V}$
		_	-2		$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		_	-6		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	-12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

#### **Electrical Characteristic**

Ta = -40 to  $85^{\circ}C$ 

Item	Symbol	V <sub>CC</sub> (V) *	Min	Тур	Max	Unit	Test condition
		1.65 to 1.95	_	_	V <sub>CC</sub> ×0.75		
	V <sub>T</sub> <sup>+</sup>	2.5	_	_	1.75		
	٧T	3.3	_	_	2.31		
		5.0	_	_	3.50		
		1.65 to 1.95	V <sub>CC</sub> ×0.25	_	_		
Threshold	V <sub>T</sub> -	2.5	0.75	_	_	V	
voltage	٧T	3.3	0.99	_	_	V	
		5.0	1.5	_	_		
		1.65 to 1.95	0.1	_	V <sub>CC</sub> ×0.4		
	41/	2.5	0.25	_	1.0		
	$\Delta V_T$	3.3	0.33	_	1.32		
		5.0	0.5	_	2.0		
		Min to Max	V <sub>CC</sub> -0.1	_	_		$I_{OH} = -50  \mu A$
		1.65	1.4	_	_		$I_{OH} = -1 \text{ mA}$
	$V_{OH}$	2.3	2.0	_	_		$I_{OH} = -2 \text{ mA}$
		3.0	2.48	_	_		$I_{OH} = -6 \text{ mA}$
Output voltage		4.5	3.8	_	_	V	I <sub>OH</sub> = -12 mA
Output voltage		Min to Max	_	_	0.1	V	$I_{OL} = 50 \mu A$
		1.65	_	_	0.3		I <sub>OL</sub> = 1 mA
	$V_{OL}$	2.3	_	_	0.4		I <sub>OL</sub> = 2 mA
		3.0	_	_	0.44		I <sub>OL</sub> = 6 mA
		4.5	_	_	0.55		I <sub>OL</sub> = 12 mA
Input current	I <sub>IN</sub>	0 to 5.5	_	_	±1	μΑ	V <sub>IN</sub> = 5.5 V or GND
Quiescent supply current	Icc	5.5	_	_	10	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
Output leakage current	I <sub>OFF</sub>	0	_	_	5	μΑ	$V_{IN}$ or $V_O = 0$ to 5.5 V
Input capacitance	C <sub>IN</sub>	3.3	_	3.0	_	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

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# **Switching Characteristics**

 $V_{CC}=1.8\pm0.15\ V$ 

Item	Symbol		Ta = 25°C	;	Ta = -40	to 85°C	Unit	Test	FROM	ТО
item	Syllibol	Min	Тур	Max	Min	Max	Onit	Conditions	(Input)	(Output)
Propagation	t <sub>PLH</sub>	_	16.8	32.0	1.0	34.0		$C_L = 15 pF$	۸	⊽
delay time	t <sub>PHL</sub>	_	23.8	43.0	1.0	46.0	ns	C <sub>L</sub> = 50 pF	A	ī

 $V_{CC}=2.5\pm0.2\ V$ 

Item	Symbol		Ta = 25°C	;	Ta = -40	to 85°C	Unit	Test	FROM	ТО
iteiii	Syllibol	Min	Тур	Max	Min	Max	Onit	Conditions	(Input)	(Output)
Propagation	t <sub>PLH</sub>	_	10.5	19.7	1.0	22.0	nc	$C_L = 15 pF$	۸	⊽
delay time	t <sub>PHL</sub>	_	14.0	24.0	1.0	27.0	ns	$C_L = 50 pF$	Α	1

 $V_{CC}=3.3\pm0.3\ V$ 

Item	Symbol	-	Ta = 25°C	;	Ta = -40	to 85°C	Unit	Test	FROM	ТО
iteiii	Syllibol	Min	Тур	Max	Min	Max	Ollit	Conditions	(Input)	(Output)
Propagation	t <sub>PLH</sub>		8.3	12.8	1.0	15.0	nc	$C_L = 15 pF$	۸	⊽
delay time	t <sub>PHL</sub>		10.8	16.3	1.0	18.5	ns	$C_L = 50 pF$	A	Ī

 $V_{CC}=5.0\pm0.5~V$ 

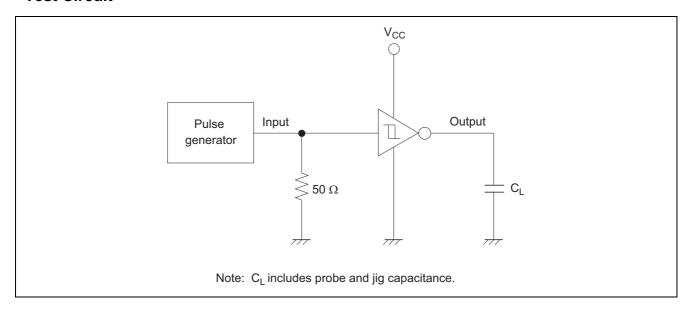
Item	Symbol	•	Ta = 25°C	;	Ta = -40	) to 85°C	Unit	Test	FROM	ТО
iteiii	Syllibol	Min	Тур	Max	Min	Max	Ollit	Conditions	(Input)	(Output)
Propagation	t <sub>PLH</sub>	_	5.5	8.6	1.0	10.0		$C_L = 15 pF$	۸	⊽
delay time	t <sub>PHL</sub>	_	7.0	10.6	1.0	12.0	ns	C <sub>L</sub> = 50 pF		ľ

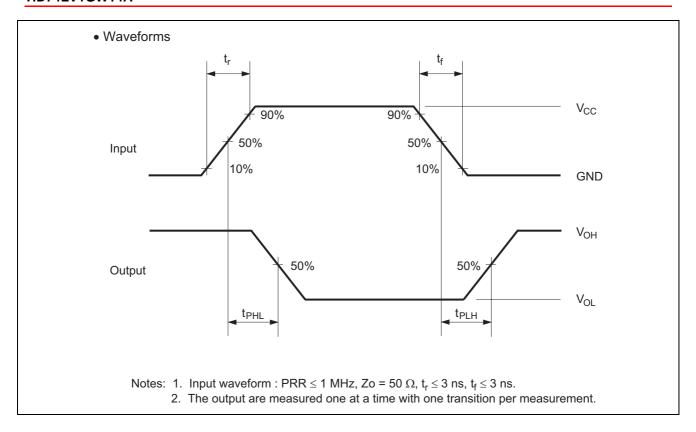
# **Operating Characteristics**

 $C_L = 50 \text{ pF}$ 

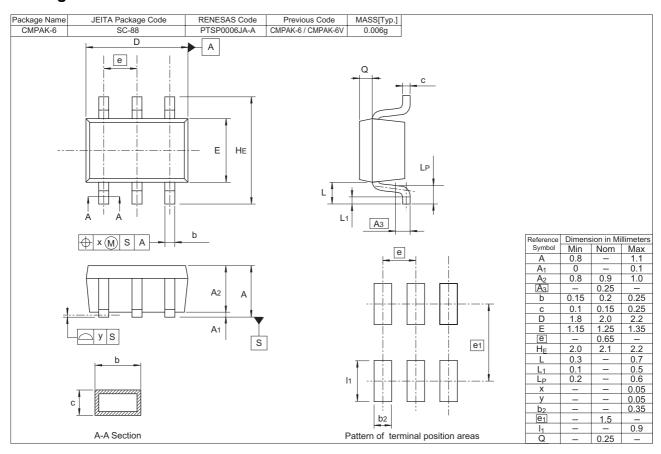
Item	Symbol	V <sub>CC</sub> (V)		Ta = 25°C	;	Unit	Test Conditions	
	Syllibol	VCC (V)	Min	Тур	Max	Unit	rest Conditions	
Power dissipation	C	3.3	_	8.5	_	pF	f = 10 MHz	
capacitance	$C_{PD}$	5.0	_	10.0	_	pr		

# **Test Circuit**





# **Package Dimensions**



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